

Joint ICTP-IAEA Advanced Workshop on High Sensitivity 2D & 3D
Characterisation and Imaging with Ion Beams | (smr 2856)

Contribution ID : 8

Type : **not specified**

Principles and application of MEIS

Tuesday, 27 September 2016 11:00 (1:00)

Content

MEIS is an ion beam characterization technique capable to determine with subnanometric depth resolution elemental composition and concentration-depth profiles in thin films. This technique is widely used for analysis of microelectronic materials as well as for the determination of structural and vibrational parameters of crystalline surfaces. In this talk the principles of MEIS will be given and a comparison with other high resolution techniques will be shown. Applications for depth profiling of thin and ultra thin films using ions and cluster ions will be provided and typical pitfalls will be discussed.

Summary

Presenter(s) : GRANDE, Pedro L. (Federal University of Rio Grande do Sul, Porto Alegre, Brazil)

Session Classification : DAY 2